

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Allen et al.

Group Art Unit: 2812

Application No.: 10/604,142

Examiner: Stevenson, Andre C.

Filing Date: 06/27/2003

Docket No.: BUR920030027US1

Title: **MASK AND SUBSTRATE ALIGNMENT FOR SOLDER BUMP PROCESS**

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

OFFICE ACTION RESPONSE

Sir:

This communication is in response to the Office Action mailed April 1, 2008.